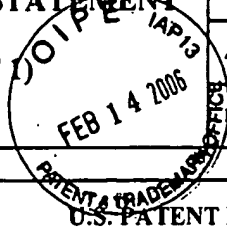


INFORMATION DISCLOSURE STATEMENT PTO-1449 (PAGE 1 OF 1)	SERIAL NUMBER	10/767,281	DOCKET NO.	P57002
	APPLICANT TAE-SUNG KIM, <i>et al.</i>			
	FILING DATE	30 January 2004	GROUP	2815



U.S. PATENT DOCUMENTS

EXAMINER	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE
<i>NEW</i>	5,747,879	05/98	Rastogi, <i>et al.</i>			
	6,083,830	07/00	Yamadai			
	5,538,921	07/96	Obeng			
	6,414,738	07/02	Fujikawa			
	6,255,706	07/01	Watanabe <i>et al.</i>			
	2001/0002050	05/01	Kobayashi, <i>et al.</i>			
	2001/0043175	11/01	Yasukawa			
	2002/0164860	11/02	Yang <i>et al.</i>			
<i>✓</i>	2002/0076574	06/02	Cabral, Jr., <i>et al.</i>			

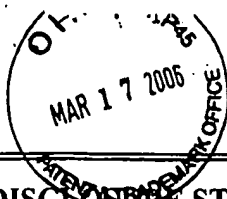
FOREIGN PATENT DOCUMENTS						TRANSLATION	
	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	YES	NO
<i>NEW</i>	EP 1 001 463	05/00	EUROPE			Abstract	

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)

<i>NEW</i>	European Office Action of the European Patent Application No. 04250862.2, mailed on 26 January 2006
<i>NEW</i>	An article "Relationship between copper concentration and stress during electromigration in an Al(0.25 at. % Cu) conductor line" written by Kao, <i>et al.</i> published in American Institute of Physics, pp2516-2527 on 1 March 2003 (with English abstract).
<i>new</i>	An article "VLSI Metallization using aluminum and its alloys" written by Pramanik, <i>et al.</i> , published in Physics & Technologies, pp 268-275 (with English abstract).

EXAMINER: <i>Muelkman</i>	DATE CONSIDERED: <i>4/27/06</i>
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EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP §609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.



INFORMATION DISCLOSURE STATEMENT

PTO-1449 (PAGE 1 OF 1)

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DOCKET NO. P57002

APPLICANT TAE-SUNG KIM, et al.

FILING DATE 30 January 2004

GROUP 2815

U.S. PATENT DOCUMENTS

EXAMINER	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE

FOREIGN PATENT DOCUMENTS

TRANSLATION

	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	YES	NO
<i>new</i>	CH 1223015	07/99	CHINA			Abstract	

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)

<i>new</i>	Chinese Office Action of the Chinese Patent Application No. 200410028732.8, issued on 27 January 2006

EXAMINER:

Matthew M

DATE CONSIDERED:

4/27/06

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INFORMATION DISCLOSURE STATEMENT

PTO-1449 (PAGE 1 OF 1)

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DOCKET NO. P57002

APPLICANT TAE-SUNG KIM, et al.

FILING DATE 30 January 2004

GROUP 2815

U.S. PATENT DOCUMENTS

EXAMINER	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE

FOREIGN PATENT DOCUMENTS

TRANSLATION

	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	YES	NO
<i>new</i>	KR 10-2002-0055436	07/02	KOREA			Abstract	

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)

<i>new</i>	Korean Office Action of the Korean Patent Application No. 10-2003-0015357, issued on 27 February 2006

EXAMINER:

Mark Wa

DATE CONSIDERED:

4/27/06

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